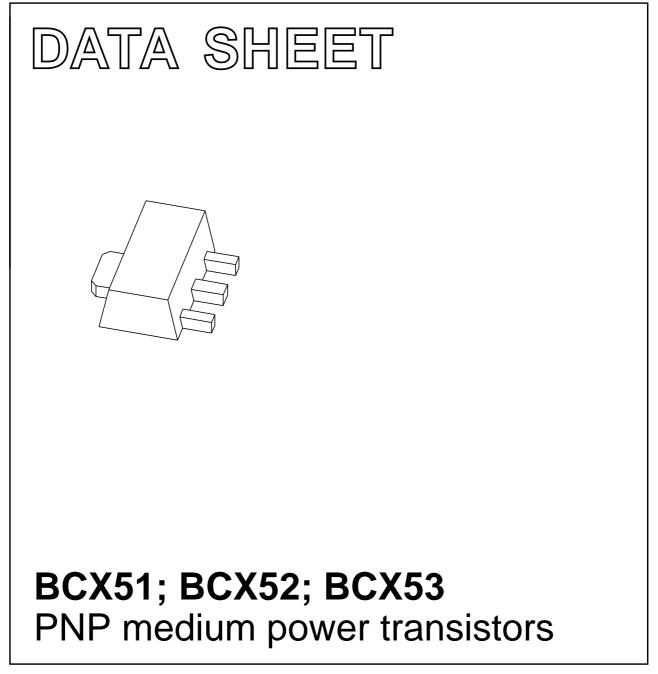
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1999 Apr 19 2001 Oct 10



FEATURES

- High current (max. 1 A)
- Low voltage (max. 80 V).

APPLICATIONS

- Medium power general purposes
- Driver stages of audio amplifiers.

DESCRIPTION

PNP medium power transistor in a SOT89 plastic package. NPN complements: BCX54, BCX55 and BCX56.

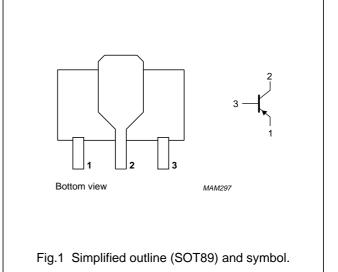
MARKING

TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE	
BCX51	AA	BCX52-16	AM	
BCX51-10	AC	BCX53	AH	
BCX51-16	AD	BCX53-10	AK	
BCX52	AE	BCX53-16	AL	
BCX52-10	AG			

BCX51; BCX52; BCX53

PINNING

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	



BCX51; BCX52; BCX53

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BCX51		_	-45	V
	BCX52		-	-60	V
	BCX53		_	-100	V
V _{CEO}	collector-emitter voltage	open base			
	BCX51		-	-45	V
	BCX52		-	-60	V
	BCX53		_	-80	V
V _{EBO}	emitter-base voltage	open collector	_	-5	V
I _C	collector current (DC)		_	-1	А
I _{CM}	peak collector current		_	-1.5	А
I _{BM}	peak base current		_	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	1.3	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 6 cm². For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	94	K/W
R _{th j-s}	thermal resistance from junction to soldering point	note 1	14	K/W

Note

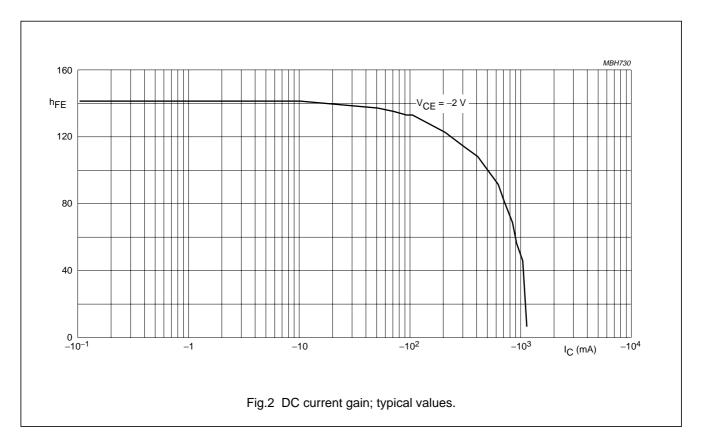
1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 6 cm². For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.

BCX51; BCX52; BCX53

CHARACTERISTICS

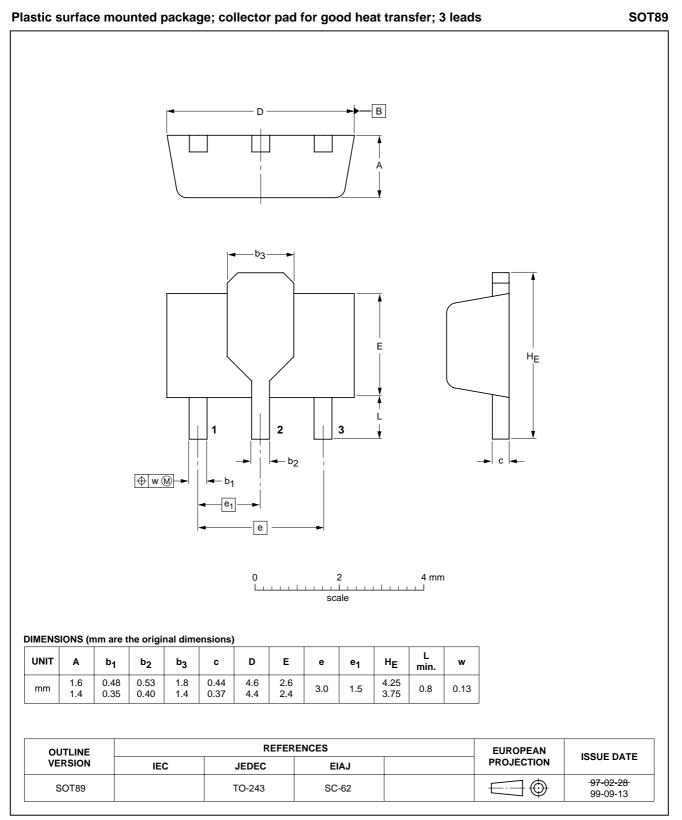
 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	$I_{E} = 0; V_{CB} = -30 V$	_	-	-100	nA
		$I_E = 0; V_{CB} = -30 V; T_j = 125 °C$	_	-	-10	μΑ
I _{EBO}	emitter cut-off current	$I_{\rm C} = 0; V_{\rm EB} = -5 \text{ V}$	_	_	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2$ V; see Fig.2				
		I _C = -5 mA	63	-	-	
		I _C = -150 mA	63	-	250	
		I _C = -500 mA	40	-	-	
	DC current gain	$I_{C} = -150 \text{ mA}; V_{CE} = -2 \text{ V}; \text{ see Fig.2}$				
	BCX51-10; BCX52-10; BCX53-10		63	-	160	
	BCX51-16; BCX52-16; BCX53-16		100	-	250	
V _{CEsat}	collector-emitter saturation voltage	$I_{\rm C} = -500 \text{ mA}; I_{\rm B} = -50 \text{ mA}$	_	-	-500	mV
V _{BE}	base-emitter voltage	$I_{\rm C} = -500 \text{ mA}; V_{\rm CE} = -2 \text{ V}$	_	-	-1	V
f _T	transition frequency	$I_{C} = -10 \text{ mA}; V_{CE} = -5 \text{ V}; f = 100 \text{ MHz}$	_	50	-	MHz



BCX51; BCX52; BCX53

PACKAGE OUTLINE



BCX51; BCX52; BCX53

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

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BCX51; BCX52; BCX53

NOTES

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Printed in The Netherlands

613514/04/pp8

Date of release: 2001 Oct 10

Document order number: 9397 750 08743

SCA73

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